

QUALCOMM INNOVATION FELLOWSHIP EAST ASIA OFFICIAL RULES

1. To Enter. The Qualcomm Innovation Fellowship East Asia (the "Program") is a student research program open to PhD students at universities listed by the Program

2. Sponsor. The Program is sponsored by Qualcomm Technologies, Inc., headquartered at 5775 Morehouse Drive, San Diego, CA 92121 ("Sponsor").

3. Application Process. An application can consist of 1 or more full-time students enrolled in a PhD program during the fellowship (the "Applicant"). Each Applicant must satisfy the below conditions:

Enrolled at one of the listed Program participating universities.

- submit the application materials described on the Program website at <https://www.qualcomm.com/research/university-relations/innovation-fellowship/2025-east-asia> (the "Website") by the date specified on the Website. Such application materials will include, at a minimum, the materials and documents described below (collectively, the "Application").
 - o Application Phase
 - A one-page abstract
 - Letter of recommendation by faculty member
 - Applicant(s) CV
 - Signed copy of QIF Rules
 - o Proposal Phase
 - Three-page Innovation Proposal (*If selected to advance to the **proposal phase***)

All materials and documents listed above must be submitted by Applicant in English.

The Applicant understands that it is the responsibility of the Applicant to complete the application materials in accordance with the instructions set forth on the Website. The Sponsor shall not accept Applications that are incomplete, have any missing information or are not submitted in accordance with the official rules and instructions provided on the Website. Any such Application shall be rejected by Sponsor.

4. Warranty. Each Applicant warrants that applied proposal, and presentation, if applicable, will not violate or infringe the rights, including, without limitation, copyrights, trademark rights or rights of publicity/privacy, of any third party, and that all pre-published material used in preparation of the paper and/or presentation is properly cited.

5. Intellectual Property. Preparation of the Application and/or presentation may produce ideas that are the intellectual property ("IP") of the Applicant and/or their papers. Participation in the Program may require disclosure of these ideas to persons who are not under a duty to maintain confidentiality (including Sponsor(s) and the judges). Sponsor reserves the right, but is not obligated, to publish information about the winning Applications and presentations on its Website or in any other media. If any Applicants are concerned about confidentiality or the protection of IP, they are urged to consider these issues with qualified advisors to make an informed decision before applying. Any IP generated by the Applicants in the preparation of their Applications and presentations will be retained by the Applicant.

Each Applicant acknowledges that Sponsor has a large research and development program with many projects currently in active development or on roadmaps. Each Applicant further acknowledges that Sponsor may already be independently conducting, or may in the future independently conduct, research that is similar to the research described in an application and/or presentation, and that Sponsor's right or ability to sell, license, use, exploit, develop or otherwise deal anywhere in any product, technology or service of any kind including those which may be similar to any product, technology or service described in an Application or presentation shall not be limited or restricted in any way related to and/or resulting from the Program and/or Applicant's participation in the Program.

6. Materials; Transmission. Application and presentation materials will not be returned. Sponsor is not responsible for, including without limitation, technical, hardware or software malfunctions, lost or unavailable network connections or failed, incorrect, inaccurate, illegible, incomplete, garbled, lost, misdirected, intercepted, late, or delayed applications, or applications or other communications not otherwise received by Sponsor, or other technical problems related to applications or the website. Sponsor, in its sole discretion, reserves the right to disqualify any applicant who tampers with the entry process, or who otherwise violates these official guidelines.

7. Selection, Notification and Finalist. Some Applicants will be selected to advance to the Proposal Phase ("Finalists") through the application review. Finalists will be invited to provide a detailed three-page proposal of the application to the Sponsor. Finalists may be asked to provide further clarification of points needed by the Sponsor. Finalists will be asked to sign and return a Qualcomm Publicity Release Form to be provided once the Applicant is selected as a Finalist.

8. Selection and Notification of Winners. All Finalists will be ranked by a panel of experts consisting of Sponsor researchers whose decisions are final on all matters relating to the Winners.

Winners will be announced on the Website and notified by email sent to the email addresses specified on each winner's Application.

9. Program Fellowship Awards. Fellowship awards of \$40,000.00 USD per selected winner will be awarded to the Applicant's affiliated university department, not to the winning Applicant(s) directly. The fellowship terms will be governed by the active University Research Collaboration Agreement in place between Sponsor and the primary Applicant's university.

10. General Conditions. Sponsor has the right to modify or cancel this competition at its sole discretion. Sponsor is not responsible for any policies, rules, or actions of the universities, conference, journal or any organization that may prevent any student from entering, participating in and/or being selected at any stage of the Program.

By applying to the Program, each Applicant agrees: (i) to be bound by these guidelines and the decisions of the judges, (ii) to be contacted by Sponsor by telephone, mail or email regarding the Program, (iii) that personal data submitted, including name, e-mail address, mobile phone number, professor, degree course, degree expected year or any other data provided by the applicant that can be used to identify or locate a person ("Personal Information"), may be collected, processed, stored and otherwise used by Sponsor for the purposes of conducting and/or administering the Program and (iv) that the Personal Information may be transmitted, processed, disclosed and/or stored by Sponsor and its affiliates and subcontractors. All Personal Information that is collected from the Applicants is subject to Qualcomm's privacy policy at <https://www.qualcomm.com/site/privacy>.

All applicable federal, state and local laws and regulations apply.

All Applicants should confirm their acceptance of these guidelines. By signing below, you accept and agree to abide by the guidelines for participation in the Program.

If there are multiple applicants, please have the primary applicant sign first in spaces provided below:

Name of Abstract Title:	
Applicant: Name (English) :	Co-Applicant, if applicable: Name (English) :
University:	University:
Signature:	Signature:
Date:	Date: